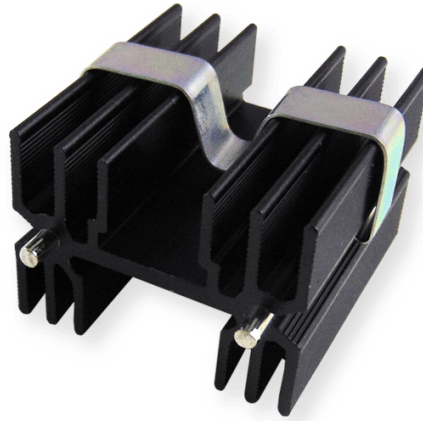


## Product features PR

### 31/38/MC

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Semiconductor casing:	TO-220 ; TO-218 ; TOP-3
Semiconductor mounted by:	Clip Mounting
Heat sink mounted by:	Solder
Finish	Black Anodised
Material	AlMgSi0,5
Width [mm]:	35.0
Height [mm]:	25.4
Length [mm]:	38.0
Min. thermal resistance [K/ W]:	7.0



## Further information

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- Special extruded heatsink for semiconductor case TO220, TO218(TOP3) - Aluminium, anodised black, solderable - Standard heights: 38, 50 and 63 mm - Version MC (Mounting clip) for clip mounting of semiconductor. - Heatsink solderable by tin plated solder pins

